



DIM500XSM65-TF000

Single Switch IGBT Module

DS6289-1 March 2019 (LN37592)

FEATURES

- 10µs Short Circuit Withstand
- High Thermal Cycling Capability
- Soft Punch Through Silicon
- Isolated AISiC Base With AIN Substrates
- Lead Free Construction

APPLICATIONS

- High Reliability Inverters
- Motor Controllers
- Traction Drives
- Choppers

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 1200V to 6500V and currents up to 2400A.

The DIM500XSM65-TF000 is a single switch 6500V, n-channel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA) plus 10µs short circuit withstand. This device is optimised for traction drives and other applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DIM500XSM65-TF000

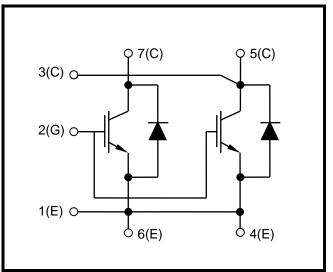
Note: When ordering, please use the complete part number

KEY PARAMETERS

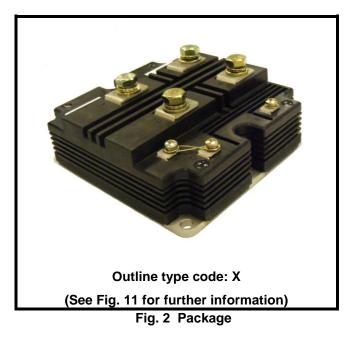
DYNEX

V _{CES}		6500V
V _{CE(sat)}	* (typ)	3.6V
I _C	(max)	500A
I _{C(PK)}	(max)	1000A

* Measured at the auxiliary terminals







Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures

ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
		$V_{GE} = 0V, T_j = 125^{\circ}C$	6500	V
V_{CES}	Collector-emitter voltage	$V_{GE} = 0V, T_j = 25^{\circ}C$	6500	V
		$V_{GE} = 0V, T_j = -40^{\circ}C$	6000	V
V_{GES}	Gate-emitter voltage		±20	V
Ι _C	Continuous collector current	T _{case} = 95°C	500	А
I _{C(PK)}	Peak collector current	1ms, T _{case} = 113°C	1000	А
P _{max}	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_j = 125^{\circ}C$	7.4	kW
l ² t	Diode l ² t value	$V_{R} = 0, t_{p} = 10ms, T_{j} = 125^{\circ}C$	180	kA ² s
V _{isol}	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	10.2	kV
Q _{PD}	Partial discharge – per module	IEC1287, $V_1 = 6900V$, $V_2 = 5100V$, 50Hz RMS	10	рС

THERMAL AND MECHANICAL RATINGS

Internal insulation material:	AIN
Baseplate material:	AISiC
Creepage distance:	56mm
Clearance:	26mm
CTI (Comparative Tracking Index):	> 600

Symbol	Parameter	Test Conditions	Min	Тур.	Мах	Units
R _{th(j-c)}	Thermal resistance – transistor	Continuous dissipation - junction to case	-	-	13.5	°C/kW
R _{th(j-c)}	Thermal resistance – diode	Continuous dissipation - junction to case	-	-	27	°C/kW
R _{th(c-h)}	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	8	°C/kW
Tj	Junction temperature	Transistor	-	-	125	°C
		Diode	-	-	125	°C
T_{stg}	Storage temperature range	-	-40	-	125	°C
		Mounting – M6	-	-	5	Nm
	Screw torque	Electrical connections – M4	-	-	2	Nm
		Electrical connections – M8	-	-	10	Nm

ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
		$V_{GE} = 0V, V_{CE} = V_{CES}$			1	mA
I _{CES}	Collector cut-off current	$V_{GE} = 0V, V_{CE} = V_{CES}, T_{case} = 125^{\circ}C$			60	mA
I _{GES}	Gate leakage current	$V_{GE} = \pm 20V, V_{CE} = 0V$			1	μA
$V_{\text{GE(TH)}}$	Gate threshold voltage	I_{C} = 120mA, V_{GE} = V_{CE}	5.5	6.5	7.5	V
v †	Collector-emitter	$V_{GE} = 15V, I_{C} = 500A$		3.6		V
V _{CE(sat)} †	saturation voltage	$V_{GE} = 15V, I_C = 500A, T_j = 125^{\circ}C$		4.3		V
١ _F	Diode forward current	DC			500	А
I _{FM}	Diode maximum forward current	t _p = 1ms			1000	А
t		I _F = 500A		3.3		V
V_{F}^{\dagger}	Diode forward voltage	I _F = 500A, T _j = 125°C		3.7		V
C _{ies}	Input capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz		8		nF
Qg	Gate charge	±15V		7		μC
C _{res}	Reverse transfer capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz		1.6		nF
L _M	Module inductance			20		nH
R _{INT}	Internal transistor resistance			180		μΩ
SC _{Data}	Short circuit current, I _{SC}	$\begin{split} T_{j} &= 125^{\circ}C, \ V_{CC} &= 4400V, \\ t_{p} &\leq 10\mu s, \ V_{GE} &\leq 15V \\ V_{CE \ (max)} &= V_{CES} - L^{*} x \ dl/dt \\ IEC \ 60747-9 \end{split}$		2500		A

Note:

[†] Measured at the auxiliary terminals ^t L is the circuit inductance + L_M

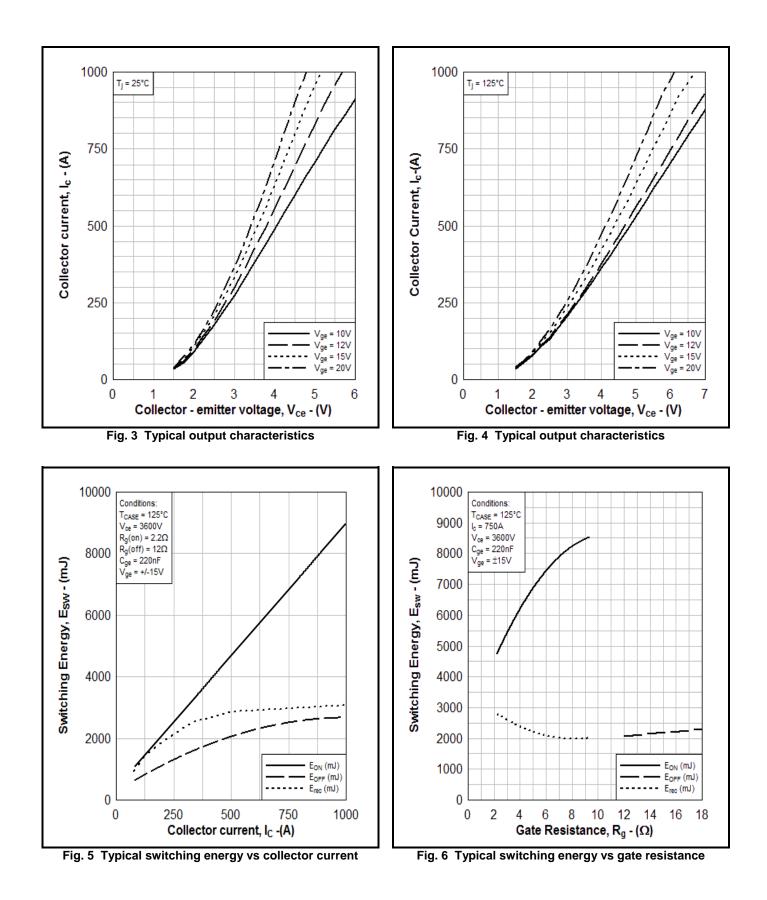
ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise

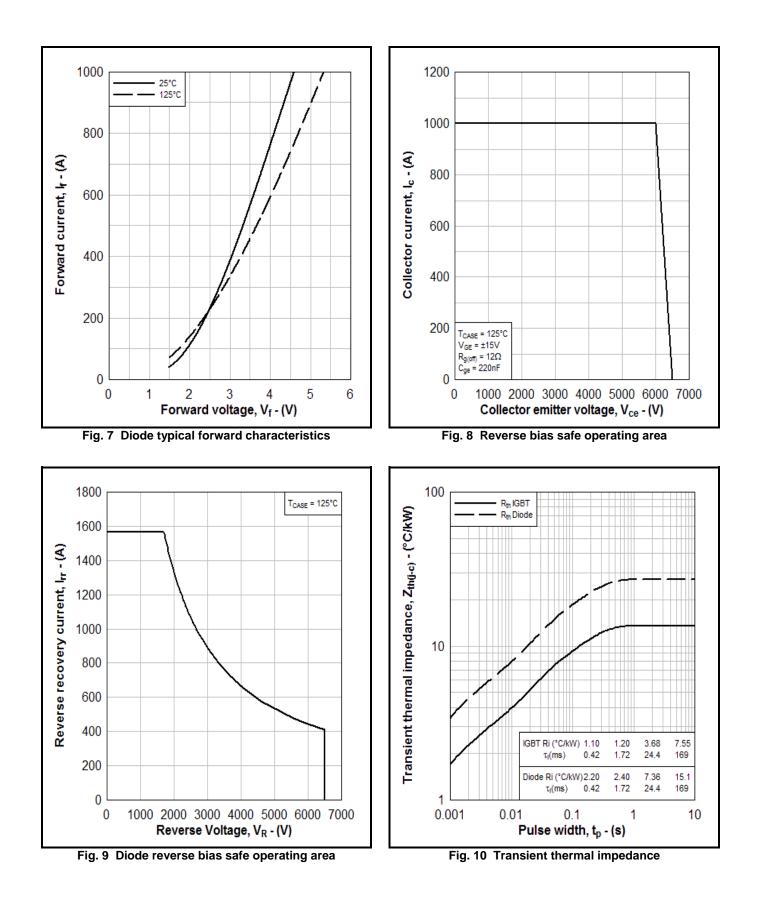
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time	I _C = 500A		3.3		μs
t _f	Fall time	$V_{GE} = \pm 15V$		360		ns
E _{OFF}	Turn-off energy loss	$V_{CE} = 3600V$		2000		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 2.2\Omega$ $R_{G(OFF)} = 12\Omega$		620		ns
tr	Rise time	$C_{ge} = 220 nF$		340		ns
E _{ON}	Turn-on energy loss	L _s ~ 200nH		3900		mJ
Q _{rr}	Diode reverse recovery charge	I _F = 500A		900		μC
Irr	Diode reverse recovery current	V _{CE} = 3600V		900		А
E _{rec}	Diode reverse recovery energy	$dI_F/dt = 2800A/\mu s$		1800		mJ

T_{case} = 125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time	I _C = 500A		3.5		μs
t _f	Fall time	$V_{GE} = \pm 15V$		360		ns
E _{OFF}	Turn-off energy loss	V _{CE} = 3600V		2050		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 2.2\Omega$ $R_{G(OFF)} = 12\Omega$		550		ns
t _r	Rise time	$C_{ge} = 220 nF$		300		ns
E _{ON}	Turn-on energy loss	L _S ~ 200nH		4700		mJ
Q _{rr}	Diode reverse recovery charge	I _F = 500A		1500		μC
I _{rr}	Diode reverse recovery current	V _{CE} = 3600V		1350		А
E _{rec}	Diode reverse recovery energy	dI _F /dt = 2800A/µs		2900		mJ



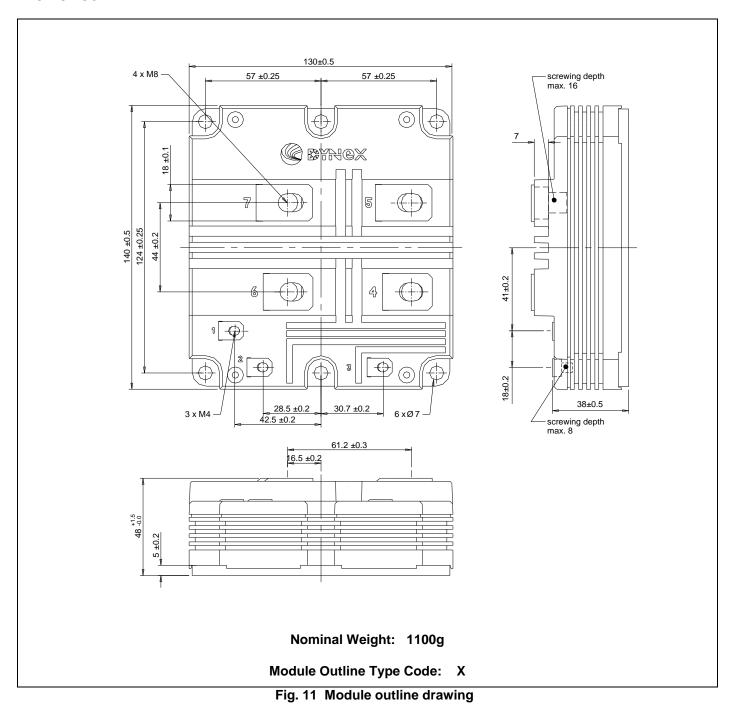
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PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise. **DO NOT SCALE.**



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DYNEX SEMICONDUCTOR LTD

Doddington Road, Lincoln, Lincolnshire, LN6 3LF, United Kingdom Fax: +44(0)1522 500550 Tel: +44(0)1522 500500 Web: <u>http://www.dynexsemi.com</u>

CUSTOMER SERVICE

DYNEX SEMICONDUCTOR LTD

Doddington Road, Lincoln, Lincolnshire, LN6 3LF, United Kingdom Fax: +44(0)1522 500020 Tel: +44(0)1522 502753 / 502901 Email: Power_solutions@dynexsemi.com

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